NXP Ucode 8

About Invengo's Bullet

Invengo

INVENGO

BULLET

WFT INI AY

Key Benefits

- Optimized size for small size hang tags
- Ideal inlay for tagging product boxes
- Serialized TID
- ISO 9001:2008 Quality Management System and ISO 14001:2004 Environment Management System support
- 100% Quality Tested

Application Areas

- Retail
- Supply Chain Management
- Packaging

The Invengo Bullet tags and inlays, equipped with the NXP Ucode 8 IC's, are designed to enable end-users to reach and sustain high levels of performance in all global RAIN RFID (UHF) frequency regions. Within the area of retail, smart packaging and supply chain management solutions, Invengo's Bullet tags and inlays can be called one of the best in class.

and many other industries. Invengo Technology Pte. Ltd. (SG) is the International Headquarters

R RAIN

Invengo – the global RFID technology provider – is a leading developer and manufacturer of high guality, intelligent RAIN RFID and HF/NFC connectivity solutions and consumables (tags & inlays) utilized in the Internet of Things. With a focus on RFID innovation, Invengo has created a leading product line in retail, (industrial) laundry, library, (public) transportation, healthcare,

of Invengo Information Technology Co., Ltd, listed on Shenzhen Stock Exchange (SZSE: 002161.SZ). Employing over 600 people globally, Invengo is one of the largest publicly traded, RFID / IoT oriented companies in the world.

100% of real size







FC EPCglobal C C ROHS

Product Specifications

ISO/IEC 18000-6C

EPCglobal C1G2

840 to 960MHz

96 bits serialized number

-40°C to 85°C (20% to 90% RH)

-20°C to 50°C (20% to 90% RH)

-40°C to 85°C (20% to 90% RH)

Min. 2 yrs from date manufacturing

 $25^{\circ}C \pm 2^{\circ}C$ (65% RH)

in 20°C (68°F) @ 50% RH

<10 MPa (10 N/mm2)

± 2000V peak

100.000 cycles

Acrylic

10 years

> 50 mm, tension max. 10 N

NXP Ucode 8

128 bits

32 bits

32 bits

RFID

Protocols Supported

Integrated Circuit (IC) Operating Frequency EPC size TID Access password Kill password

Environmental

Operating Temperature Recommended Storage Temperature Recommended Shelf Life

Bending Diameter Static Pressure ESD Adhesive Data retention Endurance

Dimensions

Antenna Size (A x B) Die-cut Size (C x D) Web Width (E) Pitch (F) PET Thickness Antenna Thickness Die-cut to edge (G) Core Size (H) 42.5 x 16 mm 44.5 x 19 mm 50 mm 22.225 mm 50 μm 10 μm 2.75 mm

76.2 mm

Order Information

Product code Packaging Box Size Weight Quantity pc p/roll; roll p/box XC-TF8013-C107+FSI Carton boxes 265×253×180mm Please check with Invengo sales 10000pcs/roll, 3rolls/box

Inlay Stackup

PET Substrate Aluminium Antenna

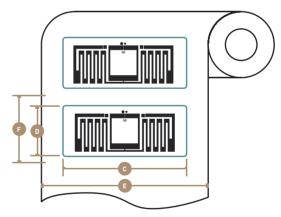
Silicone Liner

IC Adhesive

Inlay Design



Winding / Dimensions



APAC / EMEA

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